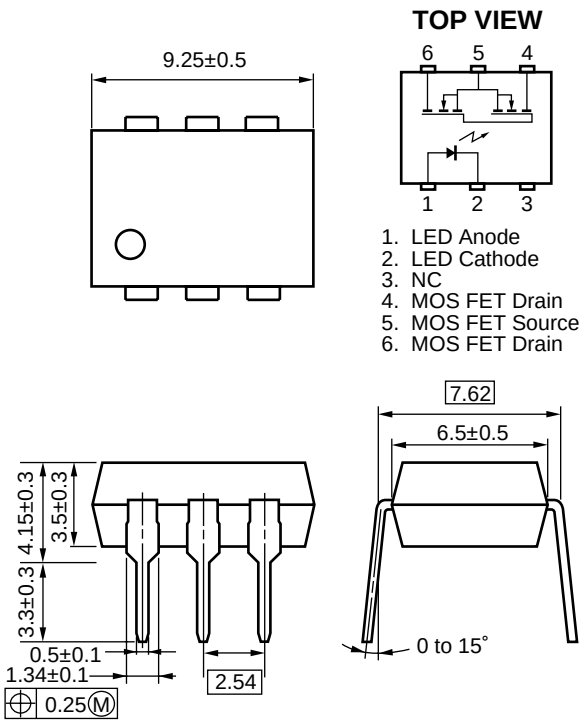
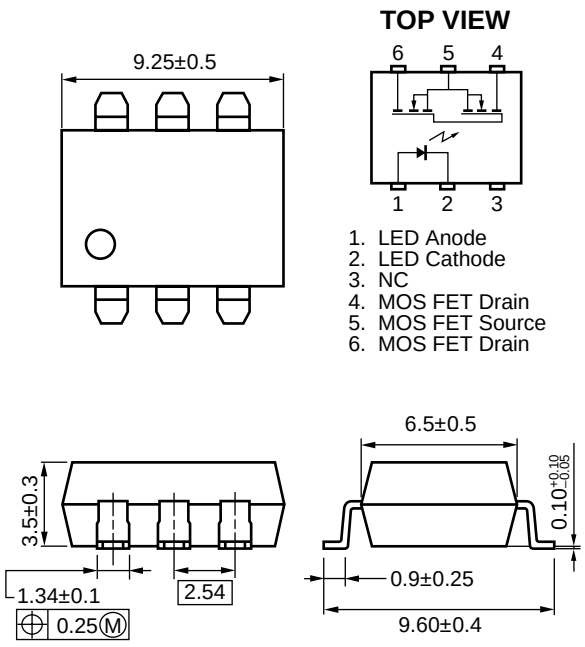
PACKAGE DIMENSIONS (in millimeters)

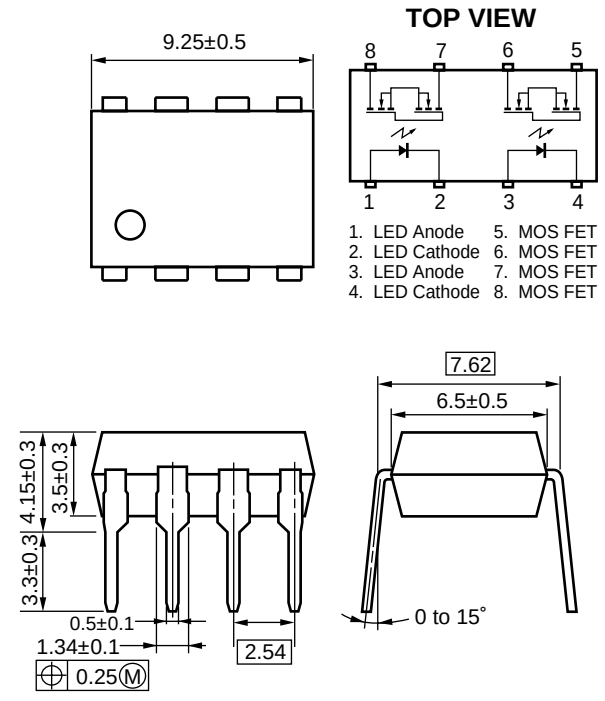
PS7122A-1A



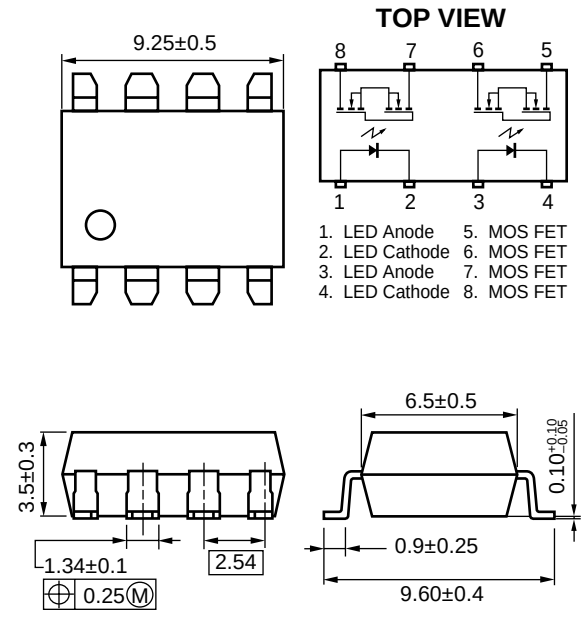
PS7122AL-1A



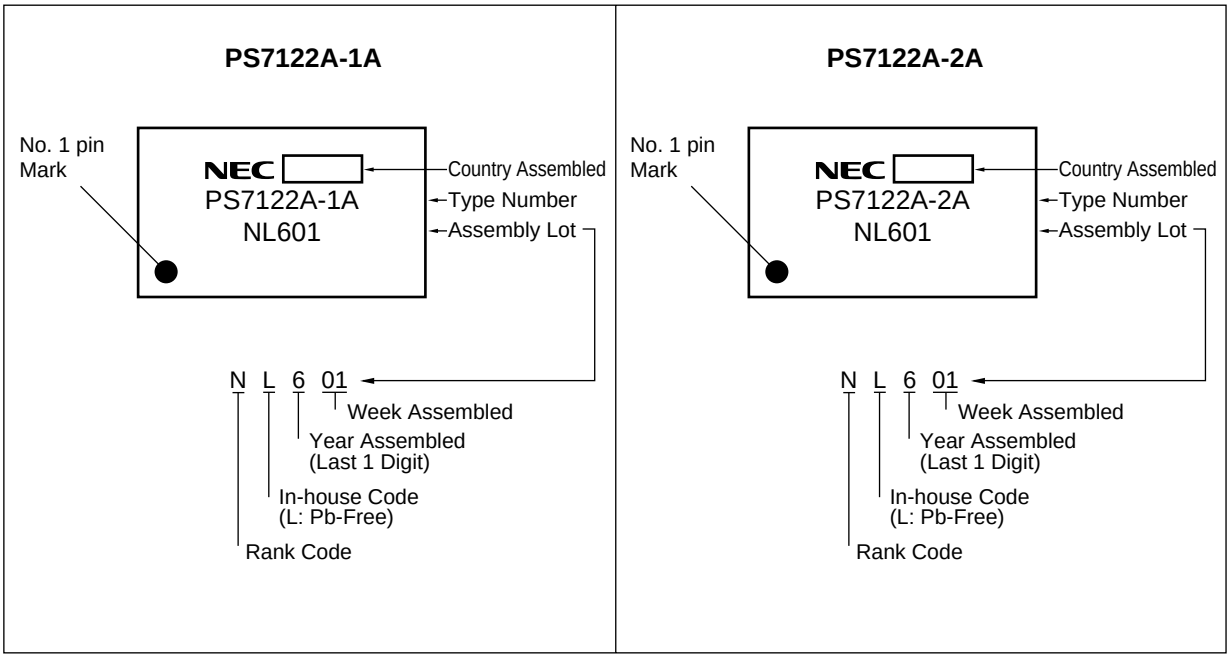
PS7122A-2A



PS7122AL-2A



<R> **MARKING EXAMPLE**



<R> **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7122A-1A	PS7122A-1A-A	Pb-Free	Magazine case 50 pcs	Standard products (UL, BSI, CSA approved)	PS7122A-1A
PS7122AL-1A	PS7122AL-1A-A				
PS7122AL-1A-E3	PS7122AL-1A-E3-A		Embossed Tape 1 000 pcs/reel		
PS7122AL-1A-E4	PS7122AL-1A-E4-A				
PS7122A-2A	PS7122A-2A-A		Magazine case 50 pcs		PS7122A-2A
PS7122AL-2A	PS7122AL-2A-A				
PS7122AL-2A-E3	PS7122AL-2A-E3-A		Embossed Tape 1 000 pcs/reel		
PS7122AL-2A-E4	PS7122AL-2A-E4-A				

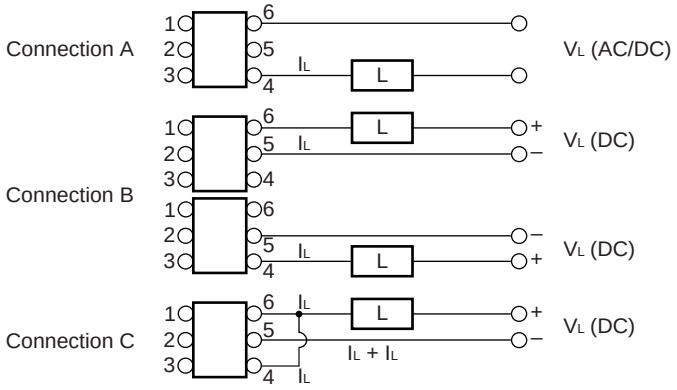
***1** For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter			Symbol	Ratings		Unit
				PS7122A-1A, PS7122AL-1A	PS7122A-2A, PS7122AL-2A	
Diode	Forward Current (DC)		I_F	50		mA/ch
	Reverse Voltage		V_R	5.0		V
	Power Dissipation		P_D	50		mW/ch
	Peak Forward Current *1		I_{FP}	1		A/ch
MOS FET	Break Down Voltage		V_L	250		V
	Continuous Load Current *2	Connection A	I_L	200		mA/ch
		Connection B		350	–	
		Connection C		500	–	
	Pulse Load Current *3 (AC/DC Connection)		I_{LP}	400		mA/ch
	Power Dissipation		P_D	560	375	mW/ch
Isolation Voltage *4			BV	1 500		Vr.m.s.
Total Power Dissipation			P_T	610	850	mW
Operating Ambient Temperature			T_A	–40 to +85		°C
Storage Temperature			T_{stg}	–40 to +100		°C

***1** PW = 100 μs, Duty Cycle = 1%

***2** Conditions: $I_F \geq 2$ mA. The following types of load connections are available.



***3** PW = 100 ms, 1 shot

***4** AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output
Pins 1-3 shorted together, 4-6 shorted together. (PS7122A-1A)
Pins 1-4 shorted together, 5-8 shorted together. (PS7122A-2A)

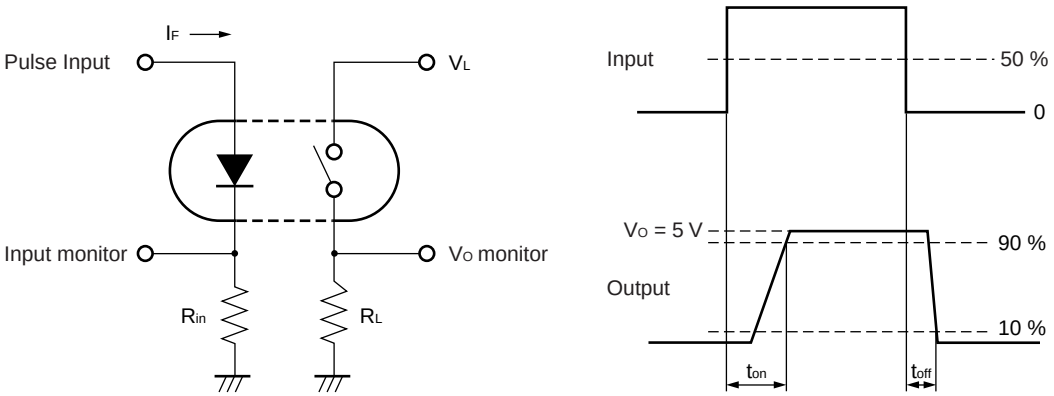
RECOMMENDED OPERATING CONDITIONS (T_A = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I_F	2	10	20	mA
LED Off Voltage	V_F	0		0.5	V

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	I_F = 10 mA		1.2	1.4	V
	Reverse Current	I_R	V_R = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	I_{Loff}	V_D = 250 V		0.03	1.0	μA
	Output Capacitance	C_{out}	V_D = 0 V, f = 1 MHz		120		pF/ch
Coupled	LED On-state Current	I_{Fon}	I_L = 200 mA			2.0	mA
	On-state Resistance	R_{on1}	I_F = 10 mA, I_L = 10 mA		4.5	8.0	Ω
		R_{on2}	I_F = 10 mA, I_L = 200 mA, t ≤ 10 ms				
	Turn-on Time *1, 2	t_{on}	I_F = 10 mA, V_O = 5 V, R_L = 500 Ω,		0.5	1.5	ms
	Turn-off Time *1, 2	t_{off}	PW ≥ 10 ms		0.04	0.2	
	Isolation Resistance	R_{I-O}	V_{I-O} = 1.0 kV_{DC}	10^9			Ω
	Isolation Capacitance	C_{I-O}	V = 0 V, f = 1 MHz		1.1		pF/ch

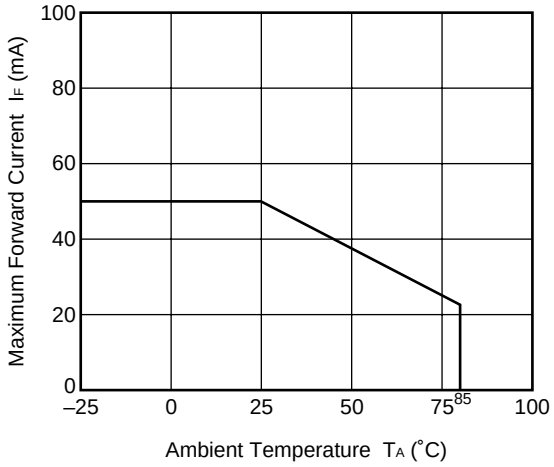
***1** Test Circuit for Switching Time



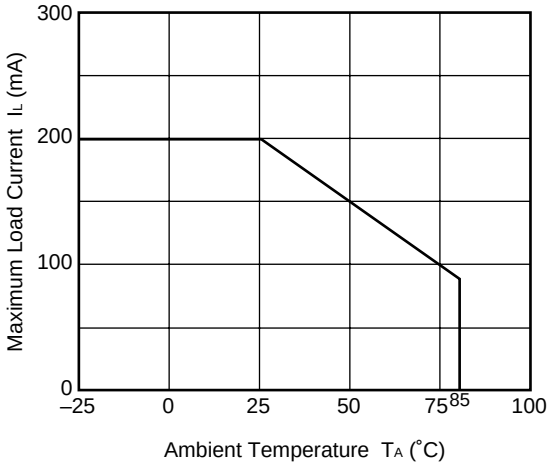
<R> ***2** The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

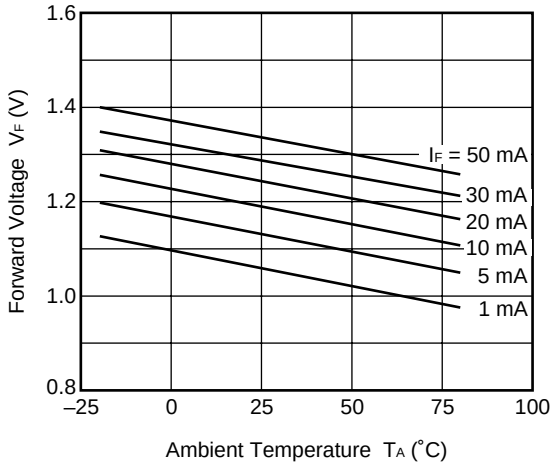
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



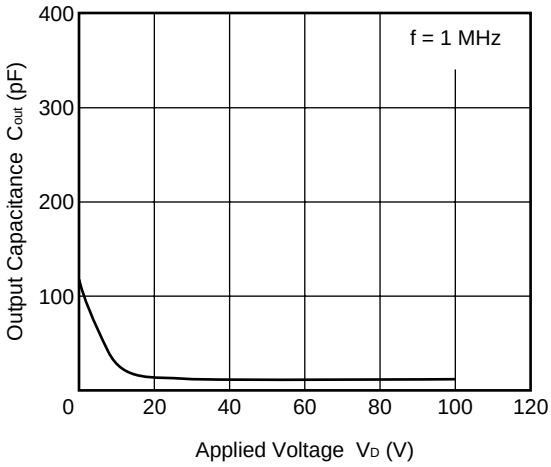
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



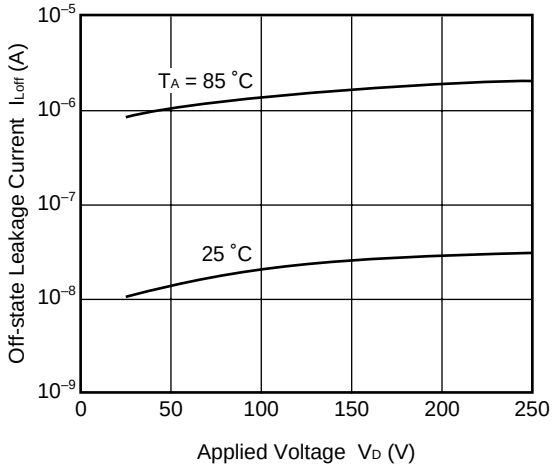
FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



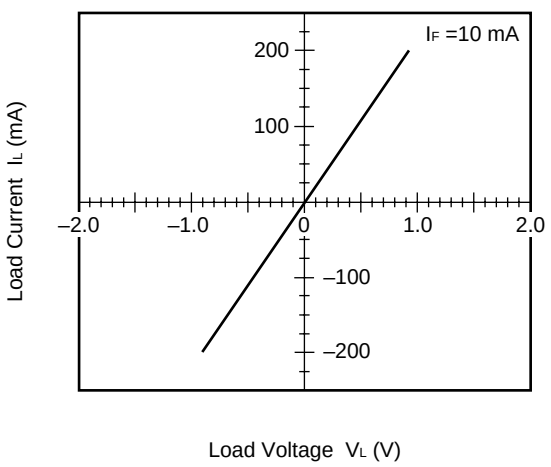
OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE

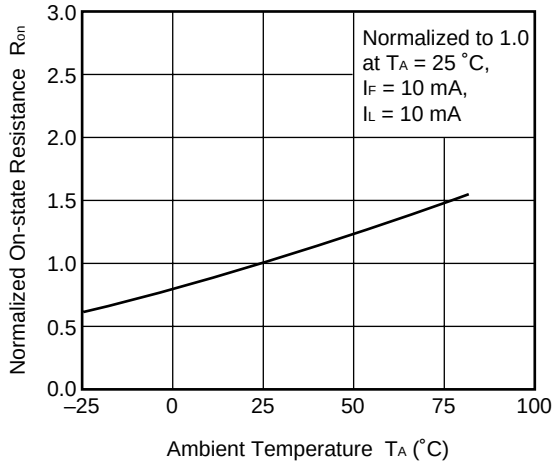


LOAD CURRENT vs. LOAD VOLTAGE

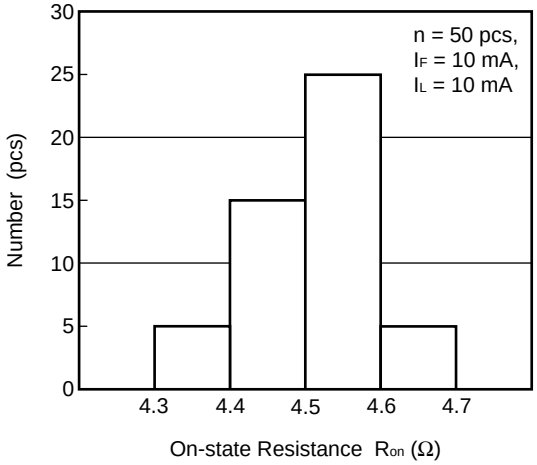


Remark The graphs indicate nominal characteristics.

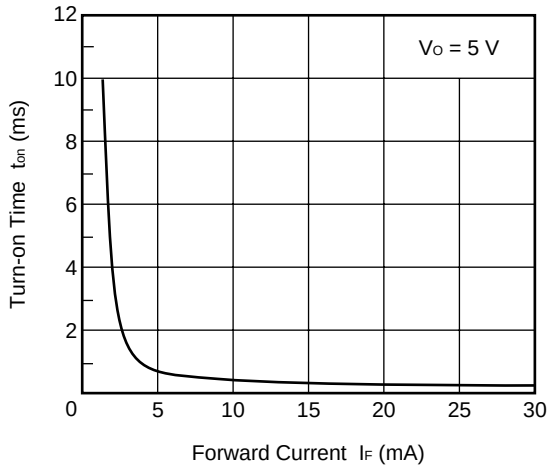
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



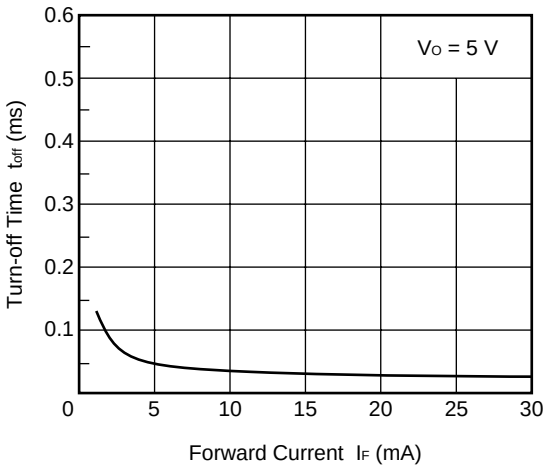
ON-STATE RESISTANCE DISTRIBUTION



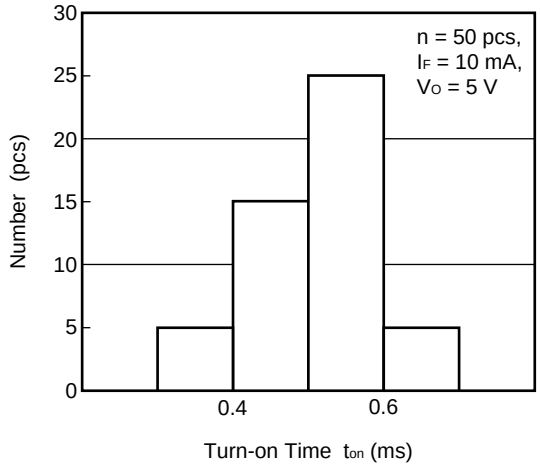
TURN-ON TIME vs. FORWARD CURRENT



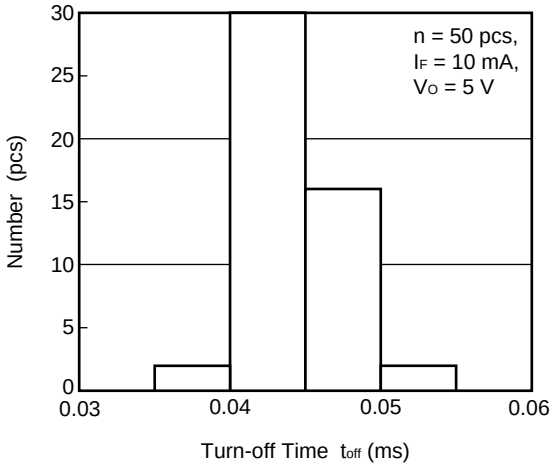
TURN-OFF TIME vs. FORWARD CURRENT



TURN-ON TIME DISTRIBUTION

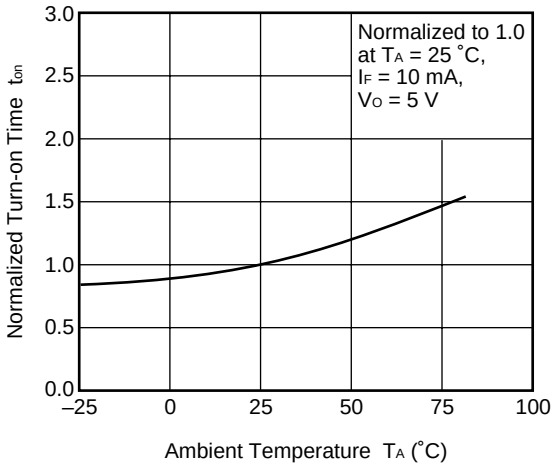


TURN-OFF TIME DISTRIBUTION

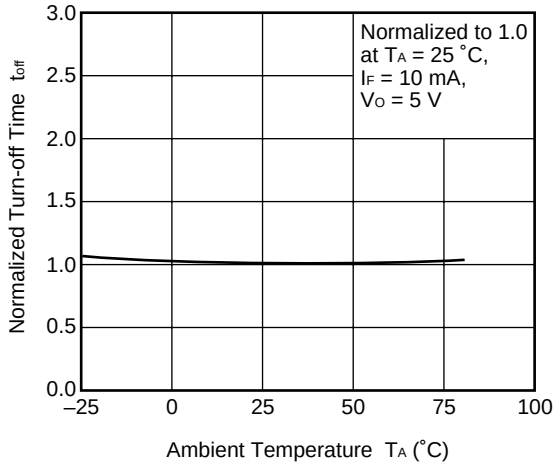


Remark The graphs indicate nominal characteristics.

NORMALIZED TURN-ON TIME vs.
AMBIENT TEMPERATURE



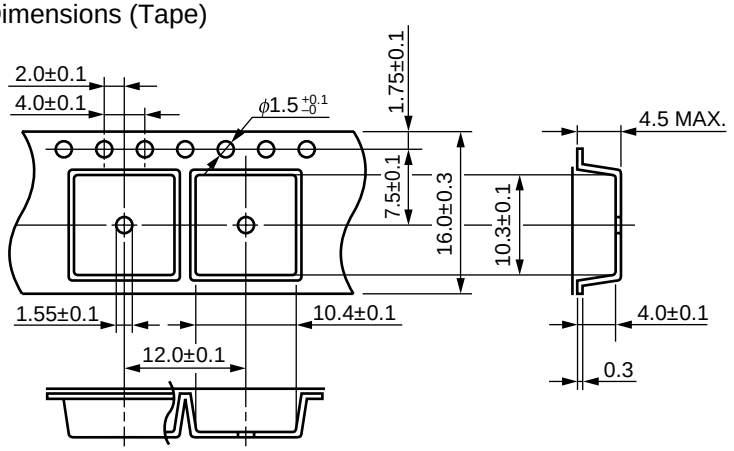
NORMALIZED TURN-OFF TIME vs.
AMBIENT TEMPERATURE



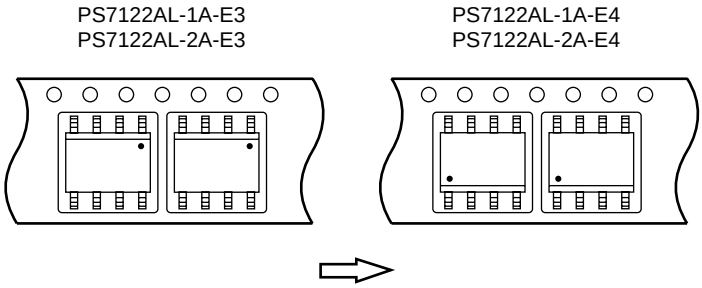
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)

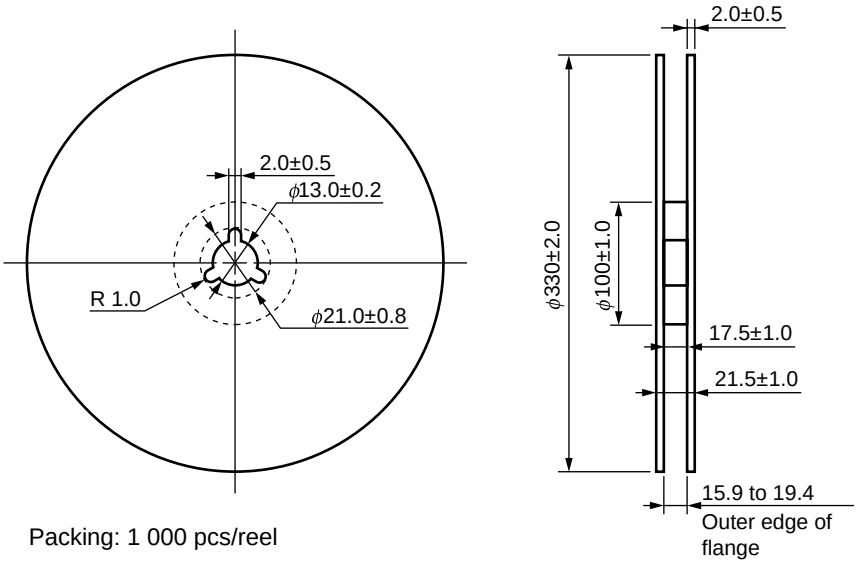
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



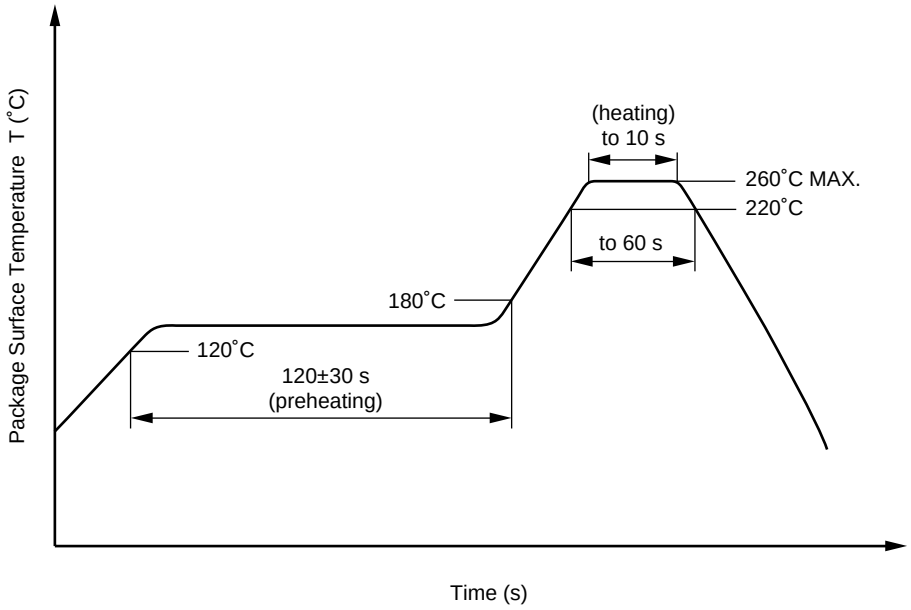
Packing: 1 000 pcs/reel

RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature — 260°C or below (package surface temperature)
- Time of peak reflow temperature — 10 seconds or less
- Time of temperature higher than 220°C — 60 seconds or less
- Time to preheat temperature from 120 to 180°C — 120±30 s
- Number of reflows — Three
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature — 260°C or below (molten solder temperature)
- Time — 10 seconds or less
- Preheating conditions — 120°C or below (package surface temperature)
- Number of times — One
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> **(3) Soldering by soldering iron**

- Peak temperature (lead part temperature) — 350°C or below
- Time (each pins) — 3 seconds or less
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes

  Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> **USAGE CAUTIONS**

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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M8E 02. 11-1

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▶**For further information, please contact**

NEC Compound Semiconductor Devices Hong Kong Limited
E-mail: contact@ncsd-hk.necel.com
Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH http://www.eu.necel.com/
TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. http://www.cel.com/
TEL: +1-408-988-3500 FAX: +1-408-988-0279

Compound Semiconductor Devices Division
NEC Electronics Corporation
URL: http://www.ncsd.necel.com/

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